


FEE TRANSMITTAL

Electronic Version v10

Stylesheet Version v10

Title of Invention	METHODS OF THINNING A SILICON WAFER USING HF AND OZONE										
Application Number :	10/631376										
Date :	2003-07-30										
First Named Applicant:	Eric J. Bergman										
Attorney Docket Number:	54008.8033.US00										
Art Unit:	1746										
Examiner :	Zeinab El-Arini										
TOTAL FEE AUTHORIZED \$ 180											
Patent fees are subject to annual revisions on or about October 1st of each year.											
<table border="1"><thead><tr><th>Fee Description</th><th>Fee Code</th><th>Amount \$</th><th>Fee Paid \$</th></tr></thead><tbody><tr><td>Submission Of Information Disclosure Stmt Fee</td><td>1806</td><td>180</td><td>180</td></tr></tbody></table>				Fee Description	Fee Code	Amount \$	Fee Paid \$	Submission Of Information Disclosure Stmt Fee	1806	180	180
Fee Description	Fee Code	Amount \$	Fee Paid \$								
Submission Of Information Disclosure Stmt Fee	1806	180	180								
AUTHORIZED BILLING INFORMATION											
The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:											
Deposit account number:	502586										
Access Code	****										
Deposit name:	Perkins Coie LLP										
Deposit authorized name:	Kenneth H. Ohriner										
Signature:	/Kenneth H. Ohriner/										
Date (YYYYMMDD):	2005-09-22										